TOSHIBA Bipolar Linear Integrated Circuit Silicon Monolithic

TA7291AP,TA7291AS(J),TA7291AF

Full-Bridge Driver for DC Motors (driver for controlling the forward and reverse rotations)

The TA7291AP/TA7291AS (J)/TA7291AF is a full-bridge driver to control the forward and reverse rotations. Each driver can select one of four modes: CW, CCW, stop, brake.

The TA7291AP is designed to provide output currents of 1.0~A~(typ.) and 2.0~A~(peak). The TA7291AS (J)/TA7291AF is designed to provide output currents of 0.4~A~(typ.) and 1.2~A~(peak).

There are two different power supply pins for each driver: one on the output side and the other on the control side of the driver. Also, there is the $V_{\rm ref}$ pin on the output side. This pin is available for adjusting the voltage supplied to the motor.

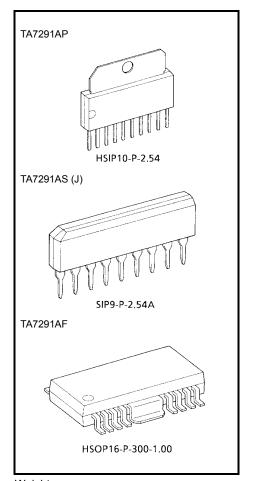
The input circuit of the driver is compatible with CMOS logic because it draws a small amount of input current.

Features

- Wide range of operating voltage: VCC (opr.) = 4.5 V to 27 V
 - : $V_{S (opr.)} = 4.5 \text{ V to } 27 \text{ V}$
 - : $V_{ref (opr.)} = 4.5 V to 27 V$

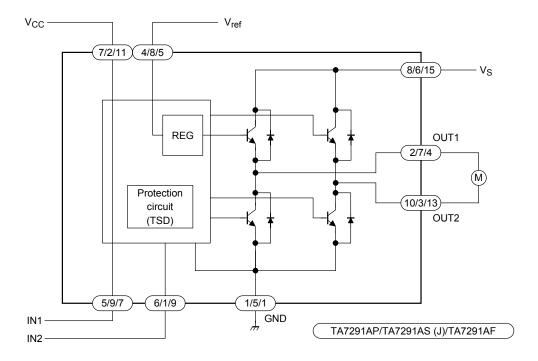
 $V_{ref} \; must \; be \leq V_S.$

- Output current: AP type 1.0 A (typ.) 2.0 A (peak)
 - : AS (J)/AF type 0.4 A (typ.) 1.2 A (peak)
- Thermal shutdown and overcurrent protection
- · Flyback diodes
- Hysteresis for all inputs
- Standby mode available



Weight HSIP10-P-2.54: 2.47 g (typ.) SIP9-P-2.54A: 0.92 g (typ.) HSOP16-P-300-1.00: 0.50 g (typ.)

Block Diagram



Pin Function

Symbol	Pin No.			Function Description	
AP AS (J) AF		Tunction Description			
V _{CC}	7	2	11	Supply voltage pin for Logic	
VS	8	6	15	Supply voltage pin for motor driver	
V _{ref}	4	8	5	Supply voltage pin for control	
GND	1	5	1	Ground pin	
IN1	5	9	7	Input pin	
IN2	6	1	9	Input pin	
OUT1	2	7	4	Output pin	
OUT2	10	3	13	Output pin	

AP type: Pin 3 and 9 are NC. AS (J) type: Pin 4 is NC.

AF type: Pin 2, 3, 6, 8, 10, 12, 14, and 16 are NC.

For F type, we recommend the fin be connected to ground.

Function

Input		Ou	tput	Mode	
IN1	IN2	OUT1	OUT2	Wiode	
0	0	∞	∞	Stop	
1	0	Н	L	CW/CCW	
0	1	L	Н	CCW/CW	
1	1	L	L	Brake	

∞: High impedance

Note: Inputs are all active high.

Maximum Ratings (Ta = 25°C)

Characteristics			Symbol	Rating	Unit	
Supply voltage			Vcc	30	V	
			V _{CC (opr.)}	27	V	
Motor drive voltage			Vs	30	V	
			V _{S (opr.)}	27	V	
Deference voltage			V _{ref}	30	V	
Reference	Reference voltage		V _{ref (opr.)}	27	V	
	Peak	AP type	lo ()	2.0		
Output	reak	AS (J)/AF type	I _{O (peak)}	1.2	Α	
current	Тур.	AP type	la a	1.0		
	тур.	A S(J)/AF type	I _{O (typ.)}	0.4		
Power dissipation AS (J) type AF type			12.5 (Note 1)			
		AS (J) type	P_{D}	0.95 (Note 2)	W	
			1.4 (Note 3)			
Operating temperature			T _{opr}	−30 to 75	°C	
Storage temperature			T _{stg}	-55 to 150	°C	

Note 1: Tc = 25°C

Note 2: No heat sink

Note 3: When mounted on a PCB (PCB area: $60 \text{ mm} \times 30 \text{ mm} \times 1.6 \text{ mm}$, Cu area: 50% or more)

Wide range of operating voltage: $V_{CC (opr.)} = 4.5 \text{ V}$ to 27 V

 $V_{S (opr.)} = 4.5 V to 27 V$

 $V_{ref (opr.)} = 4.5 V to 27 V$

 $V_{ref} \leq V_S$



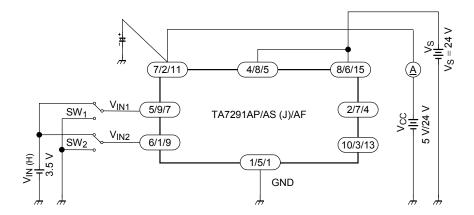
Electrical Characteristics (Ta = 25°C, V $_{CC}$ = 5 V, V $_{S}$ = 24 V)

Characteristics		Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit		
Supply current		I _{CC1-1}	1	Output OFF, CW/CCW mode	_	6.0	11.0	mA		
		I _{CC1-2}		Output OFF, CW/CCW mode, V _{CC} = 24 V	_	8.0	13.0			
		I _{CC2-1}		Output OFF, Stop mode	_	0	50			
		I _{CC2-2}		Output OFF, Stop mode, V _{CC} = 24 V	_	0	50	μА		
		I _{CC3-1}		Output OFF, Brake mode	_	4.5	8.0	mA		
		I _{CC3-2}		Output OFF, Brake mode, V _{CC} = 24 V	_	6.5	10.0			
Input	1 (High)		V _{IN1}		T. 0500	3.5	_	5.5	V	
operating voltage	2 (Low)		V _{IN2}	2	T _j = 25°C	GND	_	0.8		
Input curren	nt		I _{IN}		V _{IN} = 3.5 V, Sink mode	_	3	10	μΑ	
	AP/AS (J)/	Upper side	V _{SAT U-1}		$V_{ref} = V_S$, V_{OUT} - V_S measure $I_O = 0.2$ A, CW/CCW mode	_	0.9	1.2	V	
	AF type	Lower side	V _{SAT L-1}	3	V _{ref} = V _S , V _{OUT} -GND measure I _O = 0.2 A, CW/CCW mode	_	0.8	1.2		
Saturation	AS (J)/AF	Upper side	V _{SAT U-2}		V _{ref} = V _S , V _{OUT} -V _S measure I _O = 0.4 A, CW/CCW mode	_	1.0	1.35		
voltage	type	Lower side	V _{SAT L-2}		V _{ref} = V _S , V _{OUT} -GND measure I _O = 0.4 A, CW/CCW mode	_	0.9	1.35		
	AD turns	Upper side	V _{SAT U-3}		V _{ref} = V _S , V _{OUT} -V _S measure I _O = 1.0 A, CW/CCW mode	_	1.3	1.8		
	AP type	Lower side	V _{SAT L-3}		V _{ref} = V _S , V _{OUT} -GND measure I _O = 1.0 A, CW / CCW mode	_	1.2	1.85		
	AS (J)/AF type		VSAT U-1'	3	V _{ref} : 10 V, V _{OUT} -GND measure I _O = 0.2 A, CW / CCW mode	_	11.2	_	- v	
Output voltage			V _{SAT U-2} '		V _{ref} : 10 V, V _{OUT} -GND measure I _O = 0.4 A, CW/CCW mode	10.4	10.9	12.2		
(upper side)	AP type		V _{SAT U-3}		V_{ref} : 10 V, V_{OUT} -GND measure I_{O} = 0.5 A, CW/CCW mode	_	11.0	_		
			V _{SAT U-4} '		V_{ref} : 10 V, V_{OUT} -GND measure I_{O} = 1.0 A, CW/CCW mode	10.2	10.7	12.0		
Leakage cu	rrent	Upper side	^I L U		V _L = 30 V	_	_	50	μА	
		Lower side	ILL	4	V _L = 30 V	_	_	50		
Diode forward voltage	AS (J)/AF type	Upper side	V _{F U-1}		_	_	1.5		- V	
	AP type	Lower side	V _{F U-2}	5	_	_	2.5			
	AS (J)/AF type	Upper side	V _{F L-1}		_	_	0.9		-	
	AP type	Lower side	VF L-2		_	_	1.2			
Reference current		I _{ref}	2	V _{ref} = 10 V, Source mode	_	_	40	μΑ		

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Test Circuit 1

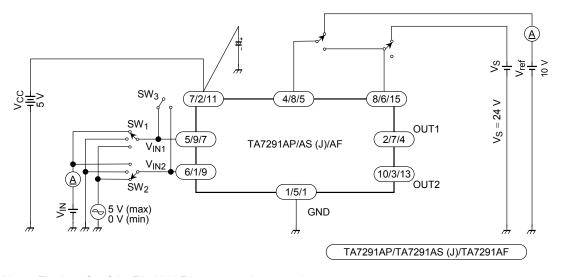
ICC1-1, ICC1-2, ICC2-1, ICC2-2, ICC3-1, ICC3-2



Note: The heat fin of the TA7291AF is connected to ground.

Test Circuit 2

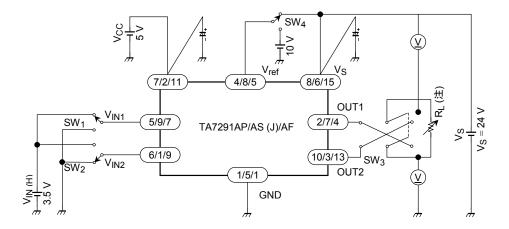
VIN1, VIN2, IIN, Iref



Note: The heat fin of the TA7291AF is connected to ground.

Test Circuit 3.

VSAT U-1, 2, 3 VSAT L-1, 2, 3 VSAT U-1', 2', 3', 4'

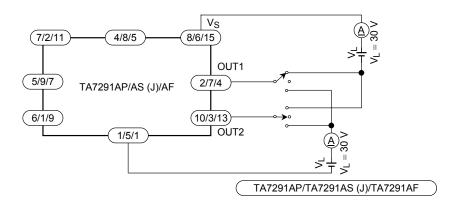


Note 1: I_{OUT} calibration is required to adjust specified values of test conditions by R_L . ($I_{OUT} = 0.2 \text{ A}/0.4 \text{ A}/0.5 \text{ A}/1.0 \text{ A}$)

Note 2: The heat fin of the TA7291AF is connected to ground.

Test Circuit 4.

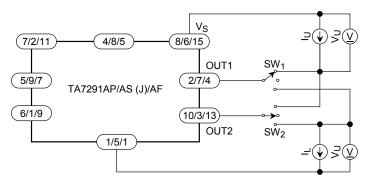
I_{LU}, L



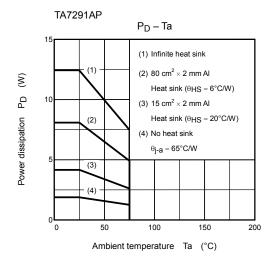
Note: The heat fin of the TA7291AF is connected to ground.

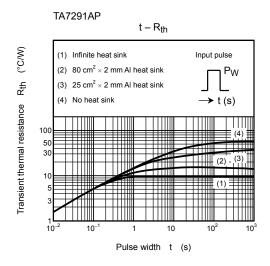
Test Circuit 5.

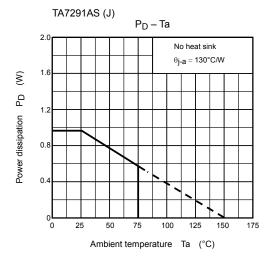
V_{F U-1}, ₂ V_{F L-1}, ₂

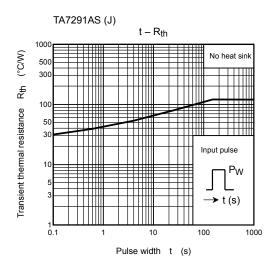


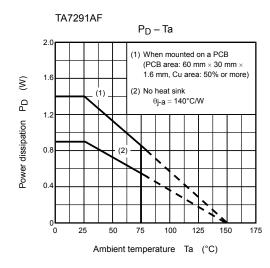
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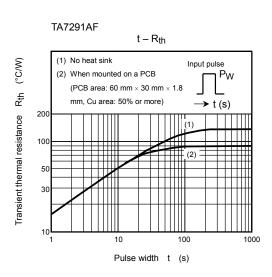




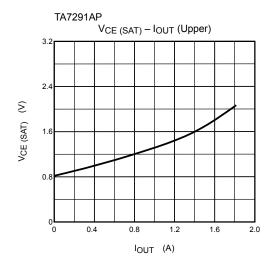


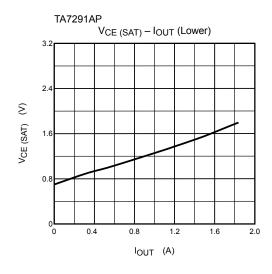


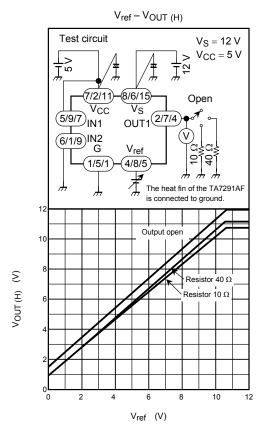


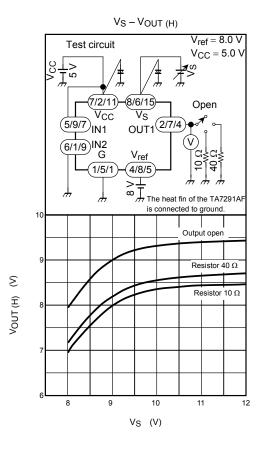


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Notes

Power On/Off

At power on, VCC must be applied simultaneously or before VS. At power off, VCC must be removed simultaneously or after VS.

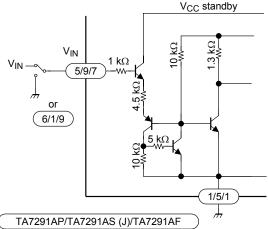
Input Circuit

A logic high on the $V_{\rm IN}$ pin activates the input circuit as shown in the figure.

When a voltage greater than or equal to V_{IN} (high) is applied to the pin, the circuit is active. When a voltage less than or equal to V_{IN} (low) is applied to the pin or the pin is grounded, the circuit is inactive.

When the pin is high, the input current I_{IN} flows into the input circuit. So, be careful about the output impedance of the first stage.

The input hysteresis is 0.7 V (typ.). At power on (V_{CC}), set both input pins IN1 and IN2 to low.



Output Circuit

Output high voltage

• Operation based on the Vrefvoltage

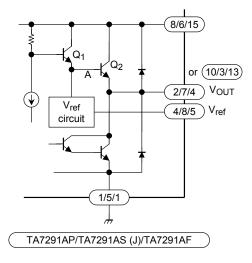
The V_{ref} voltage is increased by twice the value of V_{BE} (small signal) in the V_{ref} circuit. Then, the voltage is applied to the base A of Q2 (power transistor 2). As a result, the voltage which is reduced by the value of V_{BE} (Q2) appears on the V_{OUT} pin.

 $V_{OUT} = V_{ref} + 2V_{BE} - V_{BE} (Q_2) \simeq V_{ref} + 0.7 V$

Vref pin

The V_{ref} pin must not be left open when unused. In this case, connect it via a protection resistor (3 $k\Omega$ or more) to the $V_{\rm S}$ pin. Otherwise, it might cause oscillation.

 V_{ref} must be $\leq V_{S}$.



Protection Features

Overcurrent Protection Circuit

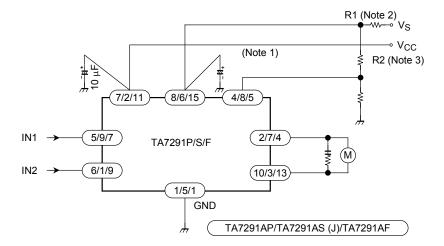
The overcurrent protection circuit detects a current flowing through the upper power transistor. If the current exceeds a predetermined value (about 2.5 A), the circuit turns all the power transistors off. However, it does not always prevent overcurrent. If an output pin is shorted or grounded, the IC might be destroyed before operation of the overcurrent protection circuit. So, be sure to connect a resistor or fuse to the power supply (VS) line. (See "Application Circuit.")

Thermal Shutdown Circuit

If the chip temperature exceeds a predetermined limit (about 170°C), the thermal shutdown circuit turns all the power transistors off.

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Application Circuit

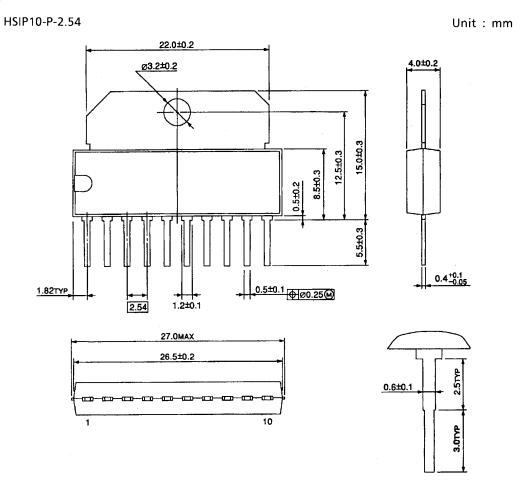


- Note 1: Select the optimum value for the capacitor by experiment.
- Note 2: Insert the current limiting resistor R1 to protect the IC from overcurrent.
- Note 3: When $V_S = V_{ref}$, insert the resistor R2 (3 k Ω or more) to protect the V_{ref} pin from being damaged by a surge.
- Note 4: The IC may be destroyed due to short circuit between output pins, an output pin and V_{CC}, or an output pin and ground. Design the output line, V_{CC} (V_M, V_S, V_{EE}) lines and the ground line with great care.

Note

- Shoot-through current occurs when the mode is switched. The driver must enter the stop mode for approximately 100 µs before switching between CW and CCW modes, or CW/CCW and brake modes.
- The proper IC functions are not guaranteed at power on/off. Before using the IC, check that any IC malfunctions that are possible at power on/off will not cause a problem in the IC application.

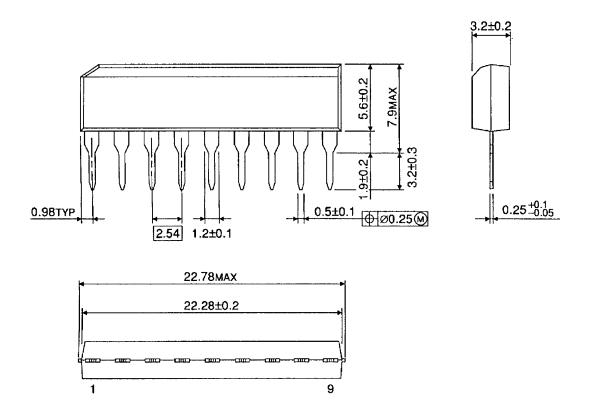
Package Dimensions



Weight: 2.47 g (typ.)

Package Dimensions

SIP9-P-2.54A Unit: mm

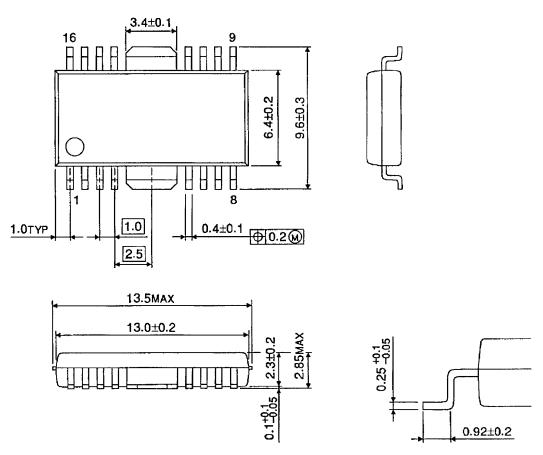


Weight: 0.92 g (typ.)

Package Dimensions

HSOP16-P-300-1.00

Unit: mm



Weight: 0.50 g (typ.)

RESTRICTIONS ON PRODUCT USE

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